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| Form 1449 (Modified) Information Disclosure Statement By Applicant (Use Several Sheets if Necessary) | Atty Docket No. 01-471/1D / LSI1P172D1 | Application No.: Filed Herewith 10/772 133 |
| | Applicant: CATABAY et al. Filing Date 2/3/04 Herewith | Group Unassigned |

U.S. Patent Documents

| Examiner Initial | No. | Patent No. | Date | Patentee | Class | Sub-class | Filing Date |
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| | I | 6,235,406 | 05/22/01 | Uzoh | 428 | 620 | 07/13/00 |

Foreign Patent or Published Foreign Patent Application

| Examiner Initial | No. | Document No. | Publication Date | Country or Patent Office | Class | Sub-class | Translation | |
|------------------|-----|--------------|------------------|--------------------------|-------|-----------|-------------|----|
| | | | | | | | Yes | No |
| | J | | | | | | | |
| | K | | | | | | | |
| | L | | | | | | | |
| | M | | | | | | | |
| | N | | | | | | | |

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| TN | P | U.S. Patent Application No. 10/035,705, "Electroless Deposition of Copper to Form Copper Interconnect Structures", filed 10/18/01. |
| | Q | |
| Examiner <i>T. Nguyen</i> | | Date Considered <i>4/6/06</i> |

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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| Examiner Initial | No. | Patent No. | Date | Patentee | Class | Sub-class | Filing Date |
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| Examiner Initial | No. | Document No. | Publication Date | Country or Patent Office | Class | Sub- class | Translation | |
|---------------------|-----|-----------------|---------------------|-----------------------------|-------|---------------|-------------|----|
| | | | | | | | Yes | No |
| | JJ | | | | | | | |
| | KK | | | | | | | |
| | LL | | | | | | | |
| | MM | | | | | | | |
| | NN | | | | | | | |

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| Examiner Initial | No. | Author, Title, Date, Place (e.g. Journal) of Publication |
|---------------------|-----------------|--|
| | OO | |
| | PP | |
| | QQ | |
| Examiner | T. NGUYEN | |
| | Date Considered | 4/6/04 |

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| | FFF | | | | | | |
| | GGG | | | | | | |
| | HHH | | | | | | |
| | III | | | | | | |

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| Examiner Initial | No. | Document No. | Publication Date | Country or Patent Office | Class | Sub-class | Translation | |
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| | JJJ | | | | | | | |
| | KKK | | | | | | | |
| | LLL | | | | | | | |
| | MMM | | | | | | | |
| | NNN | | | | | | | |

Other Documents

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|---------------------------|-----|--|
| | OOO | |
| | PPP | |
| | QQQ | |
| Examiner <i>T. NGUYEN</i> | | Date Considered <i>4/6/04</i> |

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